Microstructure control and property switching in stress-free van der Waals epitaxial VO₂ films on mica

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HIGHLIGHTS
• van der Waals epitaxy (VDWE) of non-layered stress-free VO₂ films on mica.
• Epitaxy with weak film-substrate bonding and complete interfacial stress relaxation.
• Narrow domain-size-sensitive electrical-conductivity-temperature hysteresis.
• Ab initio studies indicate that VDWE involves surface potassium atoms in the mica.

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ABSTRACT
Realizing stress-free inorganic epitaxial films on weakly bonding substrates is of importance for applications that require film transfer onto surfaces that do not seed epitaxy. Film-substrate bonding is usually weakened by harnessing natural van der Waals layers (e.g., graphene) on substrate surfaces, but this is...
1. Introduction

There is a widespread interest in integrating epitaxial thin films of inorganic materials with organic and amorphous substrates for a variety of applications in energy and electronics. Conventional thin-film epitaxial growth [1] involves a strongly bonded film-substrate interface, which is unsuitable for applications requiring free-standing films or those requiring transfer on to substrates that do not support epitaxy. Epitaxy with diminished film-substrate bonding is generically referred to as van der Waals epitaxy (VDWE) [2–3] and involves the use of surface-terminated substrates, [4] layered substrates, [5] or a two-dimensional buffer layer with no dangling bonds. [6] VDWE has been demonstrated in many organic [7] and inorganic systems. [3] On one extreme, films grown by pure VDWE are expected to be completely stress-free, regardless of lattice mismatch, due to the absence of interfacial strain, and exhibit both in-plane and out-of-plane textures. All these three attributes have been demonstrated in layered 2D materials, e.g., graphene [8–9], transition metal chalcogenides [10–12], nitrides [13] and oxides [14]. However, there are also reports of cases involving only partial strain relaxation, in particular cases where the structure, bond symmetry, and lattice parameters are similar, and can be used for strain engineering in heterostructures with mixed bonding between different layers. [15] Those cases are therefore somewhat reminiscent of conventional epitaxy where stronger bonds are involved in addition to van der Waals bonding. This more complex form of VDWE is thus distinct from the case of pure VDWE, with complete strain relaxation without interfacial misfit dislocations. In the present work, we demonstrate pure VDWE of a non-layered material with all three key characteristics, namely, full interfacial strain relaxation, and both in-plane and out-of-plane textures.

VO$_2$ is a non-layered polymorphous material with an insulator-to-metal phase transition [16–20] that renders it attractive for thermochromic [21–24] and electronic applications [25–27]. Recent works have suggested VDWE of monoclinic VO$_2$ on mica [25,28–30] and boron nitride [31], but without adequate or sufficient evidence of stress-relaxation. For example, VDWE has been claimed based solely on film texture either without measuring film strain [25], or by suggesting weak film-substrate bonding despite clear contrary evidence of significant interfacial strain [29]. VDWE has also been inferred in VO$_2$ nanorods [31] on boron nitride based on narrow metal-to-insulator transition temperature ranges similar to that in stress-free films, without evidence of out-of-plane crystallographic orientation. Establishing all three conditions is essential to definitively infer pure VDWE in non-layered materials such as VO$_2$ where strong film-substrate bonding cannot be automatically ruled out.

Our VDWE VO$_2$ films are stress-free irrespective of film thickness and exhibit out-of-plane stacking of basal planes in three in-plane domains corresponding to the threefold variants of mica substrate crystals. The results indicate that epitaxy is initiated by the nucleation of large in-plane domains that support subsequent island growth. Results of ab initio calculations reveal subtle chemical and polarization effects that induce VDWE of VO$_2$ on mica. The electrical conductivity switching hysteresis associated with the metal-insulator transition in VO$_2$ scales with the crystal domain, indicating possibilities of property tuning through microstructural control of VDWE VO$_2$ films. These findings indicate the necessity of providing evidence of all three requirements for claiming pure VDWE of non-layered materials and should be applicable to a variety of materials systems and properties.

2. Experimental and theoretical methods

2.1. Film growth

VO$_2$ thin films were deposited with thicknesses between 17 nm ≤ t$_{film}$ ≤ 180 nm by reactive pulsed magnetron sputter deposition on muscovite mica (001) substrates in a 2 × 10$^{-6}$ Torr (2.7 × 10$^{-6}$ Pa) base-pressure chamber described in detail elsewhere [50]. Immediately prior to deposition, a fresh surface of the mica substrate was exposed by peeling off the top layer by tape. During sputter deposition, the magnetron was operated at 160 W at a 50 kHz pulsing frequency and a reverse voltage that was 10% of the driving voltage for 2 s, resulting in a 90 % duty cycle. The substrate temperature was maintained at 400 °C, and a plasma struck with a 11.5 % O$_2$-88.5%Ar gas mixture resulted in a 2.3 mTorr (0.31 Pa) pressure during deposition. The film thickness was controlled by adjusting the deposition time between 5 and 60 min.

2.2. Microstructural characterization

Scanning electron microscopy (SEM) was used to observe the morphology of the films using a LEO Gemini 1550 Zeiss instrument operated at 5 kV. For transmission electron microscopy (TEM), please refer to the Supplementary Information.

A large set of X-ray diffraction (XRD) measurements were carried out to characterize various structural features of the epitaxial films. All these experiments used incident Cu K$_\alpha$ X-rays obtained from sources operated at 45 kV and 40 mA. Symmetric θ-2θ scans were acquired from the as-deposited films using a X'pert-Pro powder diffractometer with a X'Celerator detector operated in scanning line mode with a 2.122°-active length. Pole figure measurements were carried out by using a point-focus configuration together with cross slits, a parallel plate collimator, and an Xe-gas-filled proportional counter detector. We used X-ray reflectivity (XRR) measurements for film thickness determination, and reciprocal space mapping (RSM) and φ scans for quantitatively understanding the texture. These measurements were carried out using a PANa-
lytic Empyrean diffractometer equipped with a hybrid monochromator 2-bounce Ge(220) crystal in the incident beam path and a triple-axis Ge (220) 3-bounce symmetrical analyser together with a PXcels-3D detector. The thickness of the thickest film was determined by extrapolating the deposition time and thickness data from the other three films. \( t_{\text{film}} \) were determined to 17 nm, 26 nm, 62 nm, and 180 nm using XRR. Misalignments in the \( q_\| \) position of the asymmetrical reflections were corrected by the \( q_\perp \) position of the symmetrical reflections. Additionally, mosaicity broadening in \( \Delta q_\perp \) where not taken into account and a slightly larger lateral correlation length is expected.

2.3. Temperature-dependent electrical-property measurements

The conductivity of the thin films was measured in a four-probe van der Pauw configuration with a Keithley 2401 multimeter. The sample was located inside the closed chamber of a Linkam heat cell, providing a temperature stability of less than 0.01 °C, and the temperature was swept linearly from 30 °C to 90 °C and then backwards in 12 h of time to avoid any temperature offset between the thermometer and the sample.

Joule heating of the sample by the input current needs to be carefully avoided in order to correctly measure the insulator-to-metal transition versus temperature: as the conductivity endures a 3 order of magnitude change through the transition, the built-in autoregulation of the multimeter cannot be used as it happened to result in an excessive current (>100 mA) in the high-temperature (metallic) phase. To do so, at each measured temperature, a very low input current of 10 μA was first applied in order to estimate the order of magnitude of the resistance. Then an adequate current was applied depending on the resistance range, which is low enough to avoid any Joule heating of the sample, but high enough to provide a noiseless measurement of the resistance: from 10 μA for the insulating phase (\( R \sim 20 \text{k}\Omega \)) to 1 mA for the metallic phase (\( R \sim 3 \text{Ω} \)). By doing do, the Joule heating power is kept below \~3 mW in the metallic phase, which is way smaller than the heating power of the temperature cell, and it was checked that a measurement with even lower current provides exactly the same temperature dependence of the conductivity.

2.4. Ab initio methods

2.4.1. Molecular dynamics

Ab initio molecular dynamics simulations [51] (AIMD) were carried out using CP2K software suite and Quickstep module for density functional theory (DFT). We used Double-zeta plus polarization basis sets optimized for molecules (DZVP-MOLPOT) [52], Goedecker-Teter-Hutter pseudopotentials [53], and PBE functional [54] were used throughout. A 21 Å × 21 Å unit cell with 1 mica layer and 20 Å of vacuum between layers was used, where 32 VO₂ molecules were randomly placed and were allowed to fully relax and interact at 600 K for 4 ps with a 4 fs timestep, while the mica atoms remained fixed.

2.4.2. Density functional theory (DFT) calculations

Electron-transfer maps at VO₂-mica interfaces with 50% and 100% potassium coverage were obtained by subtracting the self-consistent electron density of isolated VO₂, and mica, from that of the VO₂/mica slab through DFT conjugate-gradient energy minimization. We used the VASP code with projector augmented-wave pseudopotentials [55], and combined the generalized-gradient approximation of Perdew-Burke-Ernzerhof for electronic exchange and correlation [54] with the rev-vdW-DF2 description of nonlocal correlation energies associated with long-range van der Waals interactions [56]. Since the 3d states are strongly localized in vanadium, we employed on-site Coulomb and exchange interactions of 4.2 eV and 0.8 eV, respectively, and corrected for double-counting [57].

The atomic positions for muscovite mica and monoclinic VO₂ were taken from Materials Project (mp-1200795 and mp-1102963). DFT structural relaxation was carried out to achieve 10⁻⁵ eV/supercell accuracy and atomic forces smaller than 10⁻² eV Å⁻¹. All calculations were based on Γ-point sampling of the reciprocal space and 400 eV cutoff energy for the planewave basis set. Full structural optimization of the VO₂-mica interface was achieved as follows. First, we relaxed a 30.810 Å × 17.918 Å mica surface containing 24 K, 72 Al, 72 Si, 48 H and 288 O atoms to achieve negligible stresses (<0.2 GPa). Then a VO₂ film (rotated to make a VO₂/mica interface consistent with our experimental observations) comprised of 126 V and 336 O atoms was relaxed on top of the mica substrate (966 atoms in total). A 17-Å-long vacuum region separates VO₂/mica slab replicas along the surface normal direction. Electrostatic corrections were applied to cancel spurious dipole/dipole interactions among vertical supercell replicas.

3. Results

SEM micrographs (Fig. 1) from the as-deposited VO₂ films show polycrystalline microstructures with monomodal grain size distributions [see supplementary Fig. S1]. The thinnest film, i.e., \( t_{\text{film}} = 17 \text{ nm} \) (Fig. 1a), has an average lateral grain size of 23 nm, whereas thicker films with \( 26 \leq t_{\text{film}} \leq 180 \text{ nm} \) (Fig. 1b-d) have larger average grain sizes of 55 nm ± 10 nm that do not scale with film thickness. The contrast differences observed in the SEM images (Fig. 1a-d) suggest that the thinner films are flatter than the thicker films.

X-ray diffractograms (see Fig. 2a) showing strong 020 and 040 reflections from VO₂ films indicate a strong out-of-plane 010 basal plane texture. Besides these and the 00 l mica substrate reflections, no other Bragg reflections were detectable. VO₂ deposition on amorphous SiO₂ under similar conditions do not result in such 010 texture (see supplementary Fig. S2), indicating that this texture is induced by the mica substrate. The VO₂ 0 k0 peak intensities increase monotonically with \( t_{\text{film}} \), but the 0 k0 peak positions are unchanged within experimental uncertainties for \( 17 \text{ nm} \leq t_{\text{film}} \leq 180 \text{ nm} \). The out-of-plane lattice parameter \( b = 0.452 ± 0.001 \text{nm} \) is within 0.3% of that reported [32] for unstrained VO₂ (see supplementary Fig. S3) indicating that the VO₂ films are not constrained by interfacial strain with the substrate.

Extensive attempts to carry out transmission electron microscopy (TEM) were unsuccessful due the delamination of VO₂ from the mica substrates and/or formation of \( \text{V}_2\text{O}_5 \) and carbon-vanadium compound during sample preparation by either focused ion beam milling or mechanical polishing. This outcome was not entirely unexpected, and indeed confirms weak film-substrate bonding characteristic of VDWE. Please refer to the Supplementary Information (Fig S4 and corresponding text) for more details.

All the as-deposited VO₂ films exhibit in-plane texture as well. X-ray pole figures of the 031 reflection (2θ = 65.1°) show a sextet of angularly equidistant peaks at θ = 60°, θ = 20° (see Fig. 3a-d), also observed in φ scans as shown in supplementary Fig. S5. This sextet arises from four 130- and 031-type reflections from monoclinic VO₂, where the 130 and 031 peaks are close (\( \Delta2\theta \approx 0.5° \)). In particular, the hexagonal pattern of the 130-031 doublets is obtained from three-fold rotations of a rectangle formed by 130- and 031-type reflections from monoclinic VO₂ (see Fig. 3f). The presence of threefold rotations is due to VO₂ epitaxy on threefold crystal domain variants known to exist in pseudo-close-packed substrate surfaces such as mica [33-34]. The VO₂ (1 0 0) plane normals are aligned along the close-packed-direction of such substrates [35]. Thus, each grain in the polycrystalline films exhibits...
an epitaxial relationship with the substrate, with three different possible in-plane domain orientations corresponding to the three in-plane orientational variants in the substrate.

High-resolution reciprocal space maps (RSMs) of the closely spaced 130-031 doublets and the 020 peaks (see Fig. 4) indicate that the VO₂ films are stress-free. From the 130/031 peak positions and assuming $\beta = 122.6^{\circ}$,[32] we obtain $a = 5.74 \pm 0.02$ nm, $c = 5.35 \pm 0.02$ nm for 61 nm $\leq t_{\text{film}} \leq 180$ nm. RSMs of 020 Bragg reflections yield $b = 0.4526 \pm 0.0004$ nm for 17 nm $\leq t_{\text{film}} \leq 180$ nm. These results corroborate the conclusions from Fig. 2 that the lattice parameters do not change with film thickness, with an order-of-magnitude greater precision, and confirm that all our films are stress-free.

The above results show in-plane as well as out-of-plane textures in stress-free VO₂ films, thus fulfilling the necessary conditions for VDWE. The large lattice mismatch between VO₂ and mica show that the film-substrate bonding is weak. As mentioned earlier, prior works claiming VDWE of VO₂ films demonstrated evidence for at most two of the three conditions, and in some cases assumed VDWE despite evidence to the contrary. It is important to note that the films are polycrystalline and epitaxial; each grain is epitaxially related to the substrate, with three different possible in-plane domain orientations.

Further analyses of the RSM peaks offer insights into the VDWE mechanism of VO₂ on mica. The elliptically shaped 020 peaks seen in films with $t_{\text{film}} \geq 26$ nm indicate different in-plane and out-of-plane correlation lengths. In contrast, the 020 peak for $t_{\text{film}} = 17$ nm exhibits a narrow lateral width (|| to $q_x$) indicative of large in-plane crystal domain size, and out-of-plane streaks (|| to $q_z$) expected from small out-of-plane crystal dimensions. The in-plane correlation length $d_{\text{ip}} = 2\pi/\Delta q_x$ varies in the 10 $\leq d_{\text{ip}} \leq 15$ nm range and exhibits a minimum at $t_{\text{film}} = 26$ nm (see Fig. 4h). In contrast, the out-of-plane correlation length $d_{\text{op}} = 2\pi/\Delta q_z$ monotonically increases with film thickness. The out-of-plane correlation lengths are 9 nm $\leq d_{\text{op}} \leq 38$ nm, values 40–80% lower than the film thickness except for $t_{\text{film}} = 26$ nm, where $d_{\text{op}}$ is similar to $t_{\text{film}}$. A similar lateral correlation length trend is obtained from the analyses of 130/031 asymmetric peaks[36] (see supplementary Fig. S6). Since $d_{\text{op}} > d_{\text{ip}}$ and $d_{\text{op}}$ scales monotonically with $t_{\text{film}}$, our results indicate anisotropic growth of crystal domains. The initial decrease in $d_{\text{ip}}$ suggests that large in-plane domains nucleate first, followed by further nucleation and growth influenced by factors other than the strong film-substrate bonding[37]. Upon further film growth, both $d_{\text{ip}}$ and $d_{\text{op}}$ increase. The increase of the latter at a higher rate is indicative of layer-by-layer growth of the basal planes within each crystal domain.

Fig. 1. Representative SEM micrographs from VO₂ films with thicknesses $t_{\text{film}}$ = a) 17 nm, b) 26 nm, c) 61 nm, and d) 180 nm.

Fig. 2. a) X-ray diffractograms from VO₂ films with thicknesses in the 17 nm $\leq t_{\text{film}} \leq 180$ nm range. Substrate peaks are indicated by ‘*’. (b-c) magnifications of the 020 and 040 peaks.
Based on the above results, the VDWE of VO$_2$ and mica can be described by the orientation relationship VO$_2$ [010] || mica [001] and VO$_2$ [100] || mica [100] wherein the vanadium ions overlap approximately with every third Si atom on the mica substrate surface. Three epitaxial domains of VO$_2$ are observed because the mica substrate has three variant orientations.

*Ab initio* molecular dynamics (AIMD) simulations of up to 1.5-nm-sized VO$_2$ clusters allowed to relax for up to 4 ps reveal no preferred orientations on mica surfaces with or without potassium, likely due to sub-critical VO$_2$ cluster sizes. However, our results show the presence of potassium atoms in VO$_2$ clusters even at locations away from the VO$_2$–mica interface (Fig. 5a), suggesting that the surface potassium on mica actively participates in VO$_2$ nucleation. *Ab initio* density functional theory (DFT) calculations of single-crystal VO$_2$ layers on mica (Fig. 5b–c) reveal oxygen-ligation-induced out-of-plane polarization of electron clouds around some potassium atoms (Fig. 5d–g), pointing to the genesis of van der Waals-type weak bonding interactions that promote...
epitaxy. The nearly identical electron transfer at the K-O interface seen for mica surfaces with 50% and 100% potassium coverage suggest that the threshold potassium coverage for seeding VDWE may be even less than 50%. The electron cloud polarization symmetry correlates well with the experimentally observed epitaxial configuration of VO₂ on mica. For example, the electron-depleted lobes of
potassium atoms surrounded by oxygen electron-accumulation clouds on (100) planes along [101] directions (Fig. 5d) are consistent with the experimentally determined VO₂–mica orientation relationship. These electron deficient lobes near potassium hinder the glide of VO₂ crystals along the Cartesian abscissa and ordinate directions, and likely serve as anchor pins that foster epitaxial growth. These results underscore not only the subtle role of surface chemistry on seeding VDWE, but also the importance of ab initio calculations in uncovering such effects.

The phase transition is confirmed by both ellipsometry and XRD coupled with in-situ annealing as shown in supplementary Fig. S7 and S8 and the electrical conductivity is largely affected by the transition as shown in Fig. 6 where conductivity as a function of temperature is shown. The crystal domain correlation lengths in VO₂ films strongly correlate with the electrical conductivity hysteresis characteristics associated with the monoclinic-to-rutile insulator-to-metal transition [38–39] underpinned by the higher phase transition temperature during heating (Tₜₕ) than the reverse transition during cooling (Tᵢᵢ).

Two distinct conductivity regimes are observed: 20 ≤ σₜₕ ≤ 80 S m⁻¹ and 10³ < σₜₕ < 4 × 10⁵ S m⁻¹ (see Fig. 6a–d), which is comparable to that reported previously [40]. The hysteresis loop-width decreases with increasing film thickness while transition sharpness is largely unaffected. Furthermore, Tᵢᵢ and transition width decrease linearly while Tₜₕ and σₜₕ increase as a function of dₑ and dₑₑ for 26 nm ≤ tₑₑ ≤ 180 nm (see Fig. S9 in supplementary details). These observations are consistent with previously reported [41] crystal-size dependence on the phase transition temperature. By analyzing the electrical conductivity as a function of temperature using the Arrhenius plot, we find that the activation energy is in the 0.16 ≤ Eₐ ≤ 0.27 eV range and decreases with increasing thickness. These values are close to the 0.3 eV reported for low-defect films [42–43] (see supplementary Fig. S10).

The hysteresis characteristics depend on many factors such as stress and doping, neither of which have contributions in our stress-free VDWE VO₂ films. For example, film stress has been shown to either increase or decrease Tᵢᵢ and Tₜₕ [44–45], while defects and grain size influence in nucleating the phase transition. [46–47] In this work, we hypothesize that the coherent domain size in the crystal structure is an important factor on the phase transition hysteresis shape. As the in-plane and out-of-plane correlation lengths has been shown to affect the transition temperature and hysteresis width where longer correlation lengths reduced the hysteresis width. [41,48] However, there are other studies that report opposite behavior of Tᵢᵢ and Tₜₕ with crystal size (correlation length), highlighting the complexity of the hysteresis. [49].

4. Conclusions

Epitaxial VO₂ films were grown on mica substrates using reactive pulsed magnetron sputtering. The films were stress-free and exhibited both in-plane and out-of-plane textures, showing van der Waals epitaxy. We note that without the presence of all these three parameters, VDWE cannot be inferred with certainty. Ab initio calculations show that surface potassium atoms in mica provides a mechanism for epitaxy with weak film-substate bonding. Our observations highlight the problem in the literature where VDWE is often simply assumed based on the chosen material systems, with insufficient evidence for all three factors or incorrectly inferred based merely on the assumptions on the stress-state and/or nature of the film-substrate bonding. Analyses of diffraction patterns indicate that the nucleation of large in-plane domains supports the subsequent growth of islands. The film thickness, and the epitaxial domain sizes in the films are controllable by adjusting the deposition time without any interfacial stress generation. Combining the changes in correlation length and stress-free films, a linear relation between the shape of the hysteresis and correlation length is observed in the 26 nm to 180 nm film thickness range.

Declaration of Competing Interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.
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Author contributions

E.E., B.P., F. E., A. I. F., and P.E conceived and initiated the study. F.E., B. P. G. R. and P. E. supervised the research. E.E. planned and performed all thin-film growth and characterization by XRD and SEM with input from F.E., A. I. F., B.P, G. R. and P.E wrote the manuscript with contributions from all the co-authors.

All co-authors read, edited, and commented on successive version of the manuscript.

Data availability

The data that support these findings are available from the corresponding authors on request.

Appendix A. Supplementary data

Supplementary data to this article can be found online at https://doi.org/10.1016/j.matdes.2023.111864.

References
